LM2936 Ultra-Low Quiescent Current LDO Voltage Regulator

1 Features

- LM2936 Operating V_{IN} range of 5.5 V to 40 V
- LM2936HV Operating V_{IN} range of 5.5 V to 60 V
- Ultra Low Quiescent Current (I_Q ≤ 15 µA for I_{OUT} = 100 µA)
- Fixed 3-V, 3.3-V or 5-V with 50-mA Output
- ±2% Initial Output Tolerance
- ±3% Output Tolerance Over Line, Load, and Temperature
- Dropout Voltage Typically 200 mV at I_{OUT} = 50 mA
- –24-V Input Voltage Protection
- –50-V Input Transient Protection
- Internal Short Circuit Current Limit
- Internal Thermal Shutdown Protection
- Shutdown Pin Available with LM2936BM Package

2 Applications

- Automotive
- Industrial Controls
- Point of Load

3 Description

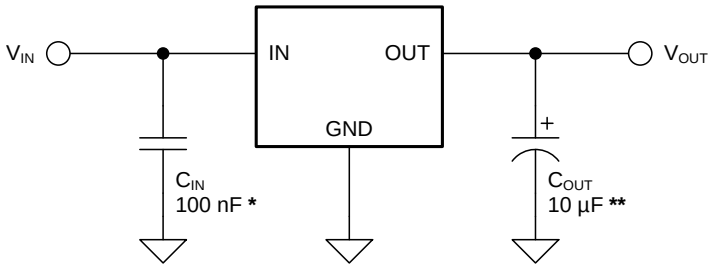
The LM2936 ultra-low quiescent current regulator features low dropout voltage and low current in the standby mode. With less than 15-µA quiescent current at a 100-µA load, the LM2936 is ideally suited for automotive and other battery operated systems. The LM2936 retains all of the features that are common to low dropout regulators including a low dropout PNP pass device, short circuit protection, reverse battery protection, and thermal shutdown. The LM2936 has a 40-V maximum operating voltage limit, a −40°C to 125°C operating temperature range, and ±3% output voltage tolerance over the entire output current, input voltage, and temperature range. The LM2936 is available in a TO-92 through-hole package, as well as SOIC-8, VSSOP, SOT–223, and TO-252 surface mount packages.

Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LM2936	SOIC (8)	4.90 mm x 3.91 mm
	TO-252 (3)	6.10 mm x 6.58 mm
	VSSOP (8)	3.00 mm x 3.00 mm
	SOT-223 (4)	6.50 mm x 3.50 mm
	TO-92 (3)	4.30 mm x 4.30 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Simplified Schematic



* Required if regulator is located more than 2″ from power supply filter capacitor.
** Required for stability. See *Electrical Characteristics for 3-V LM2936* for required values. Must be rated over intended operating temperature range. Effective series resistance (ESR) is critical, see *Typical Characteristics*. Locate capacitor as close as possible to the regulator output and ground pins. Capacitance may be increased without bound.

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision N (March 2013) to Revision O **Page**

- Added *Pin Configuration and Functions* section, *ESD Rating* table, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section ... 1

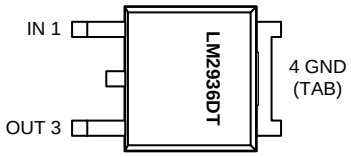
Changes from Revision M (March 2013) to Revision N **Page**

- Changed layout of National Data Sheet to TI format ... 13

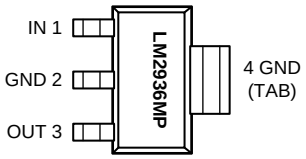
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5 Pin Configuration and Functions

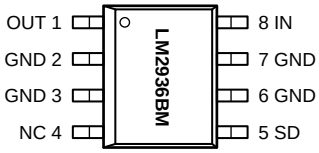
LM2936DT TO-252 (NDP) Package
3-Pins
Top View



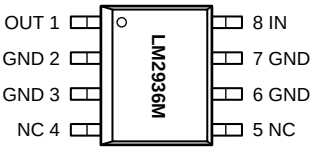
LM2936MP SOT-223 (DCY) Package
4-Pins
Top View



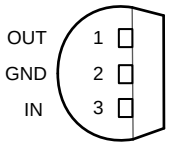
LM2936BM SOIC (D) Package
8-Pins
Top View



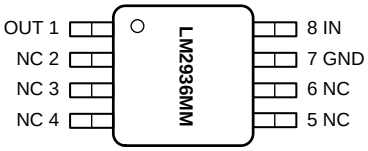
LM2936M SOIC (D) Package
8-Pins
Top View



LM2936Z TO-92 (LP) Package
3-Pins
Bottom View



LM2936MM VSSOP (DGK) Package
8-Pins
Top View



Pin Functions

PIN							I/O	DESCRIPTION
NAME	D (LM2936BM)	D (LM2936M)	NDP	DGK	DCY	LP		
IN	8	8	1	8	1	3	I	Unregulated input voltage.
GND	2, 3, 6, 7	2, 3, 6, 7	4	7	2, 4	2	—	Ground.
OUT	1	1	3	1	3	1	O	Regulated output voltage. Requires a minimum output capacitance, with specific ESR, on this pin to maintain stability.
SD	5	—	—	—	—	—	I	Shutdown. LM2936BM only. Pull this pin HIGH (> 2 V) to turn the output OFF. If this pin is left open, pull ed low (< 0.6 V), or connected to GND, the output will be ON by default. Avoid having any voltage between 0.6 V and 2 V on this pin as the output status may not be predicable across the operating range.
NC	4	4, 5	—	2, 3, 4, 5, 6	—	—	—	No internal connection, Connect to GND, or leave open.

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6 Specifications

6.1 Absolute Maximum Ratings (1)(2)

	MIN	MAX	UNIT
Input voltage (survival)	−50	60	V
Power dissipation (3)	Internally limited		
Junction temperature (T_{JMAX})		150	°C
Storage temperature, T_{stg}	−65	150	

(1) *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its specified operating ratings.
(2) If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
(3) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. If this dissipation is exceeded, the die temperature can rise above the $T_{J(MAX)}$ of 150°C, and the LM2936 may go into thermal shutdown.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. .

6.3 Recommended Operating Conditions

	MIN	MAX	UNIT
Temperature, T_J	−40	125	°C
Input voltage, V_{IN} , LM2936	5.5	40	V
Input voltage, V_{IN} , LM2936HV only	5.5	60	V
Shutdown pin voltage, V_{SD}, LM2936BM only	0	40	V

6.4 Thermal Information

THERMAL METRIC (1)		LM2936					UNIT
		SOIC (D)	TO-252 (NDP)	VSSOP (DGK)	SOT-223 (DCY)	TO-92 (LP)	
		8 PINS	3 PINS	8 PINS	4 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	111.4	50.5	173.4	62.8	156.8	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	56.3	52.6	65.9	44.2	80.4	
$R_{\theta JB}$	Junction-to-board thermal resistance	51.9	29.7	94.9	11.7	n/a	
ψ_{JT}	Junction-to-top characterization parameter	10.9	4.8	9.6	3.6	24.5	
ψ_{JB}	Junction-to-board characterization parameter	51.4	29.3	93.3	11.6	136.0	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	n/a	1.6	n/a	n/a	n/a	

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

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6.5 Electrical Characteristics for 3-V LM2936

V_{IN} = 14 V, I_{OUT} = 10 mA, T_J = 25°C, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN(1)	TYP(2)	MAX(1)	UNIT
3-V LM2936HV ONLY					
Output voltage	5.5 V ≤ V_{IN} ≤ 48 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(2) –40°C ≤ T_J ≤ 125°C	2.91	3	3.09	V
Line regulation	6 V ≤ V_{IN} ≤ 60 V, I_{OUT} = 1 mA		10	30	mV
ALL 3-V LM2936					
Output voltage		2.94	3	3.06	V
	4 V ≤ V_{IN} ≤ 26 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(2) –40°C ≤ T_J ≤ 125°C	2.91	3.000	3.09	
Quiescent current	I_{OUT} = 100 µA, 8 V ≤ V_{IN} ≤ 24 V		15	20	µA
	I_{OUT} = 10 mA, 8 V ≤ V_{IN} ≤ 24 V		0.2	0.5	mA
	I_{OUT} = 50 mA, 8 V ≤ V_{IN} ≤ 24 V		1.5	2.5	mA
Line regulation	9 V ≤ V_{IN} ≤ 16 V		5	10	mV
	6 V ≤ V_{IN} ≤ 40 V, I_{OUT} = 1 mA		10	30	
Load regulation	100 µA ≤ I_{OUT} ≤ 5 mA		10	30	mV
	5 mA ≤ I_{OUT} ≤ 50 mA		10	30	
Dropout voltage	I_{OUT} = 100 µA		0.05	0.1	V
	I_{OUT} = 50 mA		0.20	0.40	V
Short-circuit current	V_{OUT} = 0 V	65	120	250	mA
Output impedance	I_{OUT} = 30 mAdc and 10 mArms, f = 1000 Hz		450		mΩ
Output noise voltage	10 Hz–100 kHz		500		µV
Long-term stability			20		mV/1000 Hr
Ripple rejection	V_{ripple} = 1 V_{rms}, f_{ripple} = 120 Hz	−40	−60		dB
Reverse polarity transient input voltage	R_L = 500 Ω, t = 1 ms	−50	−80		V
Output voltage with reverse polarity input	V_{IN} = −15 V, R_L = 500 Ω		0	−0.3	V
Maximum Line Transient	R_L = 500 Ω, V_{OUT} ≤ 3.3 V, T = 40 ms	60			V
Output bypass capacitance (C_{OUT}) ESR	C_{OUT} = 22 µF, 0.1 mA ≤ I_{OUT} ≤ 50 mA	0.3		8	Ω
SHUTDOWN INPUT − 3-V LM2936BM ONLY					
Output voltage, V_{OUT}	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500 Ω		0	0.01	V
Shutdown high threshold voltage, V_{IH}	Output off, R_{LOAD} = 500 Ω	2	1.1		V
Shutdown low threshold voltage, V_{IL}	Output on, R_{LOAD} = 500 Ω		1.1	0.6	V
Shutdown high current, I_{IH}	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500Ω		12		µA
Quiescent current	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500 Ω, includes I_{IH} current		30		µA

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.
(2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.

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6.6 Electrical Characteristics for 3.3-V LM2936

V_{IN} = 14 V, I_{OUT} = 10 mA, T_J = 25°C, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN(1)	TYP(2)	MAX(1)	UNIT
3.3-V LM2936HV ONLY					
Output voltage	5.5 V ≤ V_{IN} ≤ 48 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(3) –40°C ≤ T_J ≤ 125°C	3.201	3.300	3.399	V
Line regulation	6 V ≤ V_{IN} ≤ 60 V, I_{OUT} = 1 mA		10	30	mV
ALL 3.3-V LM2936					
Output voltage		3.234	3.300	3.366	V
	4 V ≤ V_{IN} ≤ 26 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(3) –40°C ≤ T_J ≤ 125°C	3.201	3.300	3.399	
Quiescent current	I_{OUT} = 100 µA, 8 V ≤ V_{IN} ≤ 24 V		15	20	µA
	I_{OUT} = 10 mA, 8 V ≤ V_{IN} ≤ 24 V		0.2	0.5	mA
	I_{OUT} = 50 mA, 8 V ≤ V_{IN} ≤ 24 V		1.5	2.5	mA
Line regulation	9 V ≤ V_{IN} ≤ 16 V		5	10	mV
	6 V ≤ V_{IN} ≤ 40 V, I_{OUT} = 1 mA		10	30	
Load regulation	100 µA ≤ I_{OUT} ≤ 5 mA		10	30	mV
	5 mA ≤ I_{OUT} ≤ 50 mA		10	30	
Dropout voltage	I_{OUT} = 100 µA		0.05	0.10	V
	I_{OUT} = 50 mA		0.2	0.4	V
Short-circuit current	V_{OUT} = 0 V	65	120	250	mA
Output impedance	I_{OUT} = 30 mAdc and 10 mArms, f = 1000 Hz		450		mΩ
Output noise voltage	10 Hz–100 kHz		500		µV
Long-term stability			20		mV/1000 Hr
Ripple rejection	V_{ripple} = 1 V_{rms}, f_{ripple} = 120 Hz	−40	−60		dB
Reverse polarity transient input voltage	R_L = 500 Ω, T = 1 ms	−50	−80		V
Output voltage with reverse polarity input	V_{IN} = −15 V, R_L = 500 Ω		0	−0.3	V
maximum line transient	R_L = 500 Ω, V_{OUT} ≤ 3.63 V, T = 40 ms	60			V
Output bypass capacitance (C_{OUT}) ESR	C_{OUT} = 22 µF, 0.1 mA ≤ I_{OUT} ≤ 50 mA	0.3		8	Ω
SHUTDOWN INPUT − 3.3-V LM2936BM ONLY					
Output voltage, V_{OUT}	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500 Ω		0	0.01	V
Shutdown high threshold voltage, V_{IH}	Output off, R_{LOAD} = 500 Ω	2	1.1		V
Shutdown low threshold voltage, V_{IL}	Output on, R_{LOAD} = 500 Ω		1.1	0.6	V
Shutdown high current, I_{IH}	Output off, V_{SD} = 2.4V, R_{LOAD} = 500 Ω		12		µA
Quiescent current	Output off, V_{SD} = 2.4V, R_{LOAD} = 500 Ω, includes I_{IH} current		30		µA

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.
(2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.
(3) To ensure constant junction temperature, pulse testing is used.

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6.7 Electrical Characteristics for 5-V LM2936

V_{IN} = 14 V, I_{OUT} = 10 mA, T_J = 25°C, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN(1)	TYP(2)	MAX(1)	UNIT
5-V LM2936HV ONLY					
Output voltage	5.5 V ≤ V_{IN} ≤ 48 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(3) –40°C ≤ T_J ≤ 125°C	4.85	5	5.15	V
Line regulation	6 V ≤ V_{IN} ≤ 60 V, I_{OUT} = 1 mA		15	35	mV
ALL 5-V LM2936					
Output voltage		4.9	5	5.1	V
	5.5 V ≤ V_{IN} ≤ 26 V, 100 µA ≤ I_{OUT} ≤ 50 mA,(3) –40°C ≤ T_J ≤ 125°C	4.85	5	5.15	
Quiescent current	I_{OUT} = 100 µA, 8 V ≤ V_{IN} ≤ 24 V		9	15	µA
	I_{OUT} = 10 mA, 8 V ≤ V_{IN} ≤ 24 V		0.2	0.5	mA
	I_{OUT} = 50 mA, 8 V ≤ V_{IN} ≤ 24 V		1.5	2.5	mA
Line regulation	9 V ≤ V_{IN} ≤ 16 V		5	10	mV
	6 V ≤ V_{IN} ≤ 40 V, I_{OUT} = 1 mA		10	30	
Load regulation	100 µA ≤ I_{OUT} ≤ 5 mA		10	30	mV
	5 mA ≤ I_{OUT} ≤ 50 mA		10	30	
Dropout voltage	I_{OUT} = 100 µA		0.05	0.1	V
	I_{OUT} = 50 mA		0.2	0.4	V
Short-circuit current	V_{OUT} = 0 V	65	120	250	mA
Output impedance	I_{OUT} = 30 mAdc and 10 mArms, f = 1000 Hz		450		mΩ
Output noise voltage	10 Hz–100 kHz		500		µV
Long-term stability			20		mV/1000 Hr
Ripple rejection	V_{ripple} = 1 V_{rms}, f_{ripple} = 120 Hz	−40	−60		dB
Reverse polarity transient input voltage	R_L = 500 Ω, T = 1 ms	−50	−80		V
Output voltage with reverse polarity input	V_{IN} = −15 V, R_L = 500 Ω		0	−0.3	V
Maximum line transient	R_L = 500 Ω, V_{OUT} ≤ 5.5 V, T = 40 ms	60			V
Output bypass capacitance (C_{OUT}) ESR	C_{OUT} = 10 µF, 0.1 mA ≤ I_{OUT} ≤ 50 mA	0.3		8	Ω
SHUTDOWN INPUT − 5-V LM2936BM ONLY					
Output voltage, V_{OUT}	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500 Ω		0	0.01	V
Shutdown high threshold voltage, V_{IH}	Output off, R_{LOAD} = 500 Ω	2	1.1		V
Shutdown low threshold voltage, V_{IL}	Output on, R_{LOAD} = 500 Ω		1.1	0.6	V
Shutdown high current, I_{IH}	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500 Ω		12		µA
Quiescent current	Output off, V_{SD} = 2.4 V, R_{LOAD} = 500Ω, includes I_{IH} current		30		µA

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.
(2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.
(3) To ensure constant junction temperature, pulse testing is used.

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6.8 Typical Characteristics

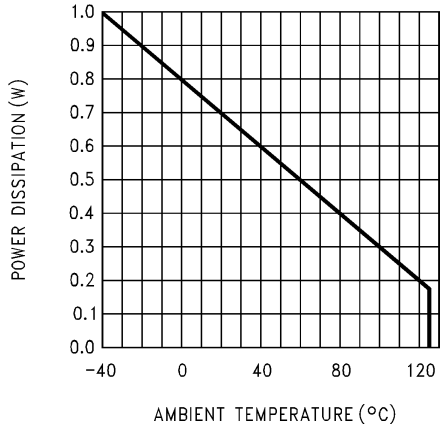


Figure 1. Maximum Power Dissipation (TO-92)

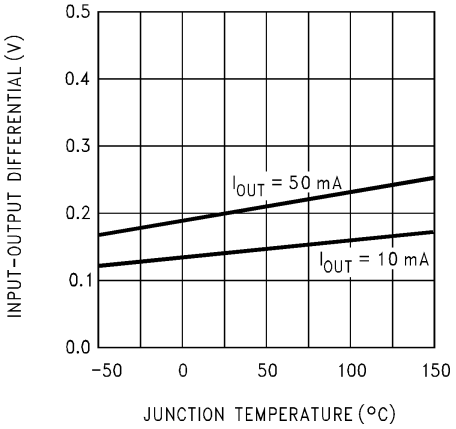


Figure 2. Dropout Voltage

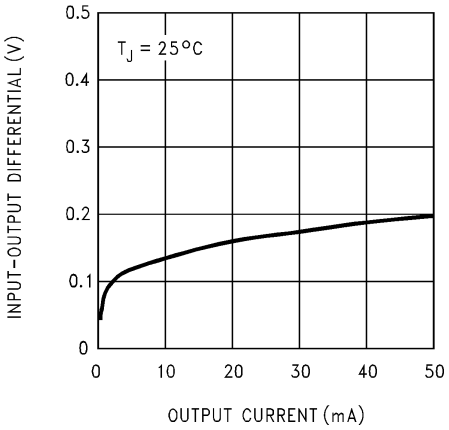


Figure 3. Dropout Voltage

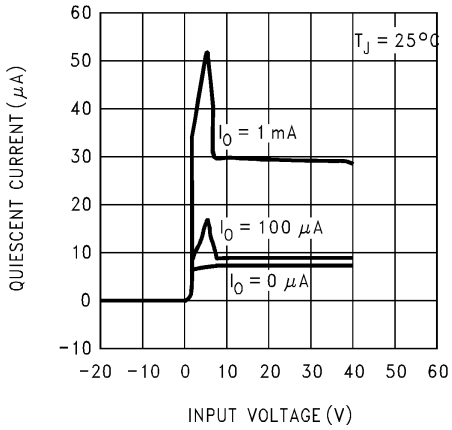


Figure 4. Quiescent Current

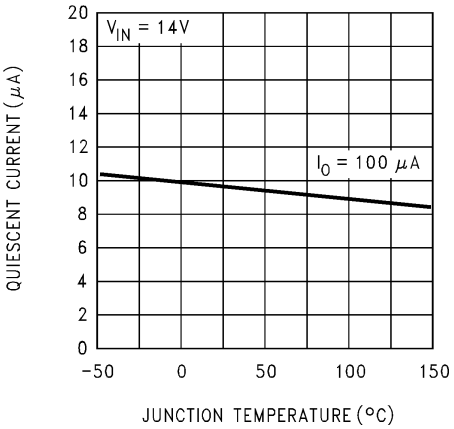


Figure 5. Quiescent Current

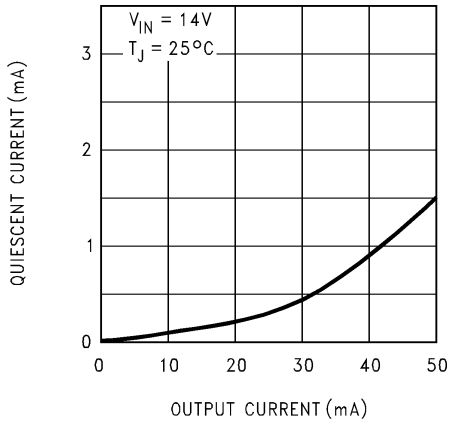


Figure 6. Quiescent Current

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Typical Characteristics (continued)

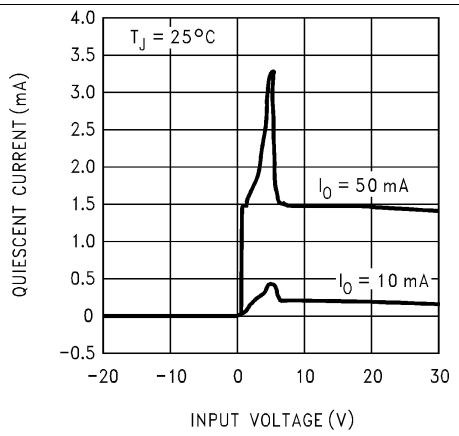


Figure 7. Quiescent Current

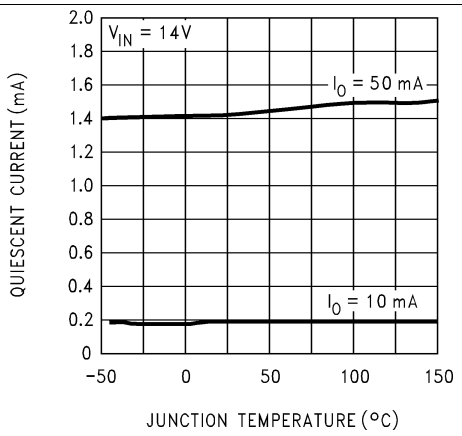


Figure 8. Quiescent Current

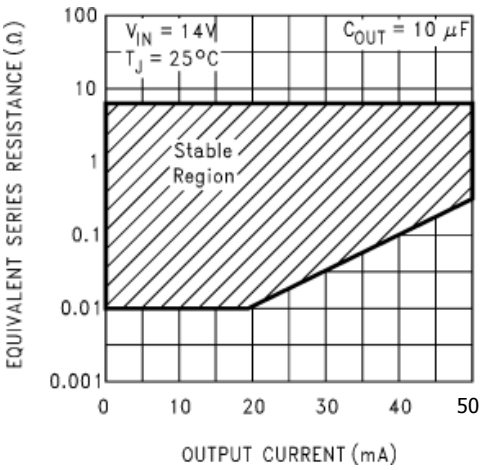


Figure 9. 5-V LM2936 C_{OUT} ESR

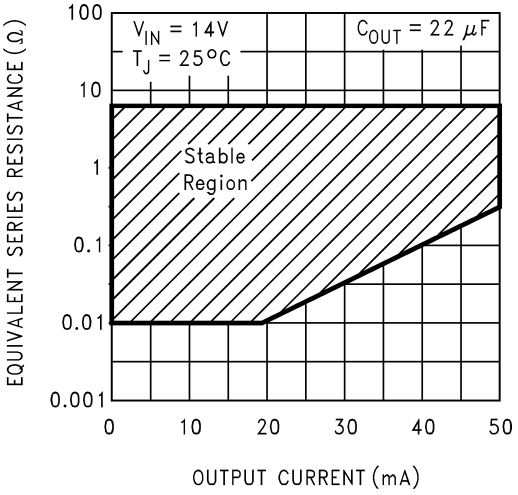


Figure 10. 3-V LM2936 C_{OUT} ESR

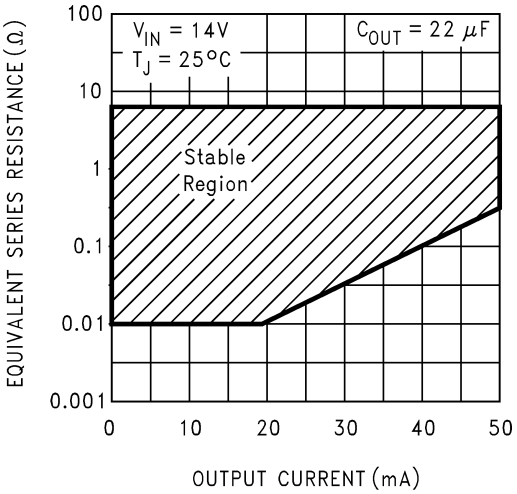


Figure 11. 3.3-V LM2936 C_{OUT} ESR

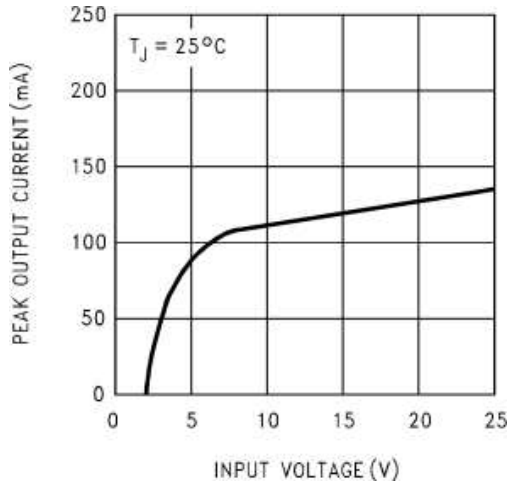


Figure 12. Peak Output Current

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Typical Characteristics (continued)

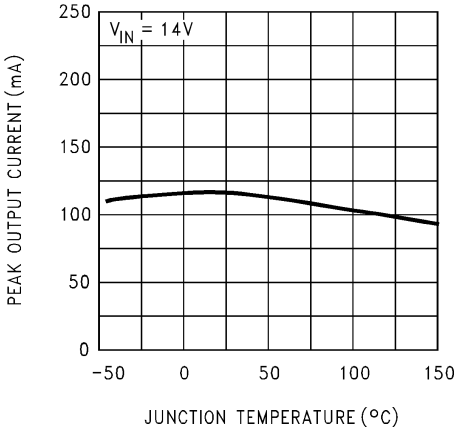


Figure 13. Peak Output Current

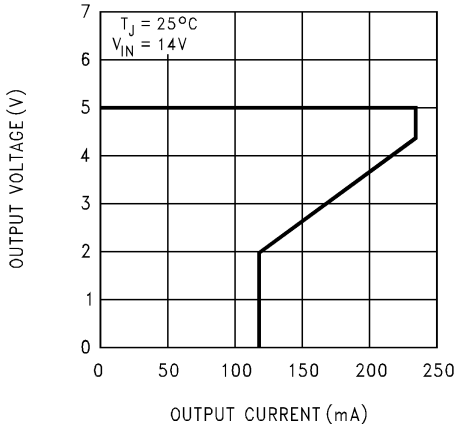


Figure 14. 5-V LM2936 Current Limit

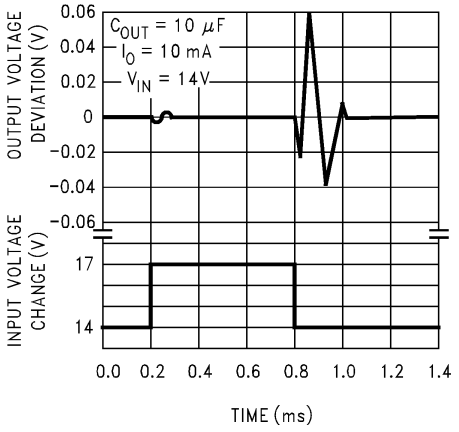


Figure 15. 5-V LM2936 Line Transient Response

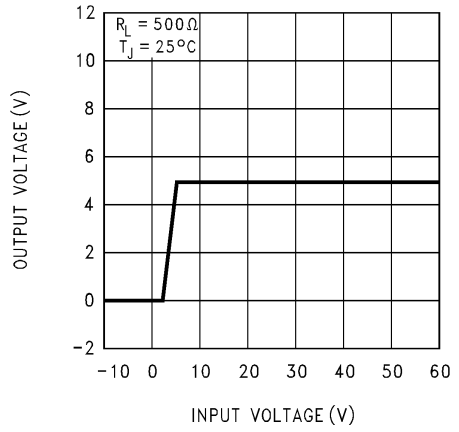


Figure 16. 5-V LM2936 Output at Voltage Extremes

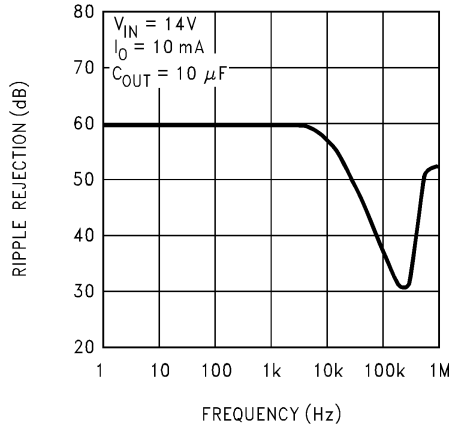


Figure 17. 5-V LM2936 Ripple Rejection

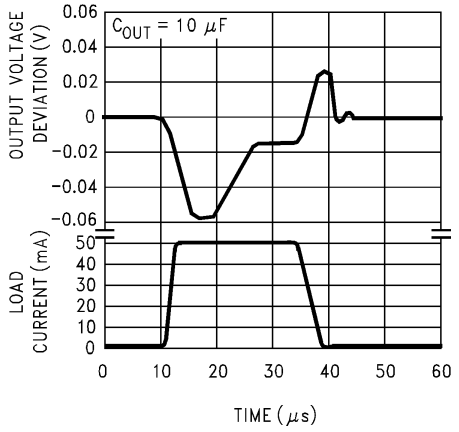


Figure 18. 5-V LM2936 Load Transient Response

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Typical Characteristics (continued)

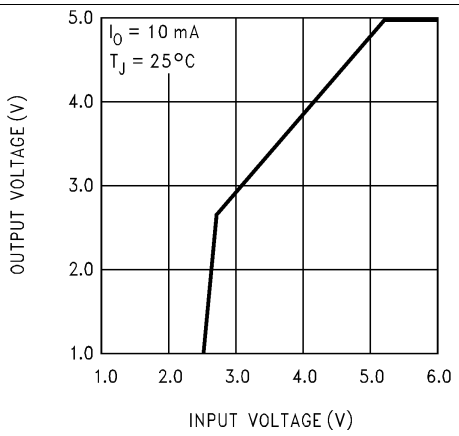


Figure 19. 5-V LM2936 Low Voltage Behavior

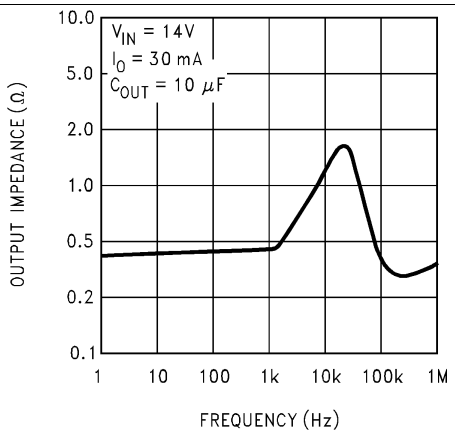


Figure 20. 5-V LM2936 Output Impedance

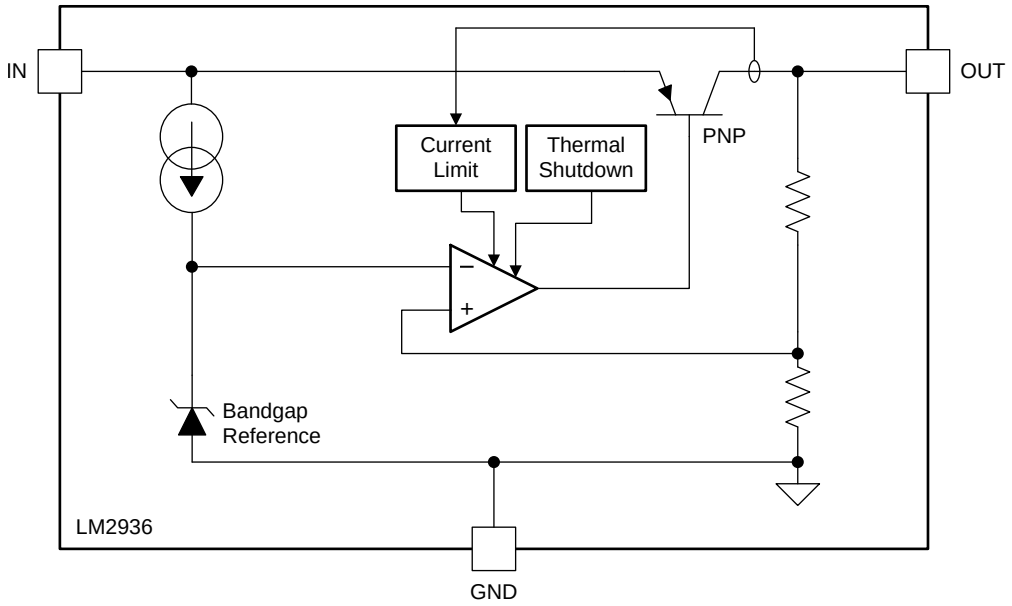
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7 Detailed Description

7.1 Overview

The LM2936 ultra-low quiescent current regulator features low dropout voltage and low current in the standby mode. With less than 15 µA quiescent current at a 100-µA load, the LM2936 is ideally suited for automotive and other battery operated systems. The LM2936 retains all of the features that are common to low dropout regulators including a low dropout PNP pass device, short circuit protection, reverse battery input protection, and thermal shutdown. The LM2936 has a 40-V maximum operating voltage limit, a −40°C to 125°C operating temperature range, and ±3% output voltage tolerance over the entire output current, input voltage, and temperature range.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 High Input Operating Voltage

Unlike namy other PNP low dropout regulators, the LM2936 remains fully operational with V_{IN} = 40 V, and the LM2936HV remains fully operational with V_{IN} = 60 V . Owing to power dissipation characteristics of the available packages, full output current cannot be ensured for all combinations of ambient temperature and input voltage.

While the LM2936HV maintains regulation to 60 V, it will not withstand a short circuit to ground on the output when V_{IN} is above 40 V because of safe operating area limitations in the internal PNP pass device. Above 60V the LM2936 will break down with catastrophic effects on the regulator and possibly the load as well. Do not use this device in a design where the input operating voltage may exceed 40 V, or where transients are likely to exceed 60 V.

7.3.2 Thermal Shutdown (TSD)

The TSD circuitry of the LM2936 has been designed to protect the device against temporary thermal overload conditions. The TSD circuitry is not intended to replace proper heat-sinking. Continuously running the LM2936 device at TSD may degrade device reliability as the junction temperature will be exceeding the absolute maximum junction temperature rating. If the LM2936 goes into TSD mode, the output current will be shut off until the junction temperature falls approximately 10°C, then the output current will automatically be restored. The LM2936 will continuously cycle in and out of TSD until the condition is corrected. The LM2936 TSD junction temperature is typically 160°C.

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Feature Description (continued)

7.3.3 Short-Circuit Current Limit

The output current limiting circuitry of the LM2936 has been designed to limit the output current in cases where the load impedance is unusually low. This includes situations where the output may be shorted directly to ground. Continuous operation of the LM2936 at the current limit will typically result in the LM2936 transitioning into TSD mode.

7.3.4 Shutdown (SD) Pin

The LM2936BM has a pin for shutting down the regulator output. Applying a Logic Level High (> 2 V) to the SD pin will cause the output to turn off. Leaving the SD pin open, connecting it to Ground, or applying a Logic Level Low (< 0.6 V) will allow the regulator output to turn on.

7.4 Device Functional Modes

The LM2936 design does not include any undervoltage lockout (UVLO), or overvoltage shutdown (OVSD) functions. Generally, the output voltage will track the input voltage until the input voltage is greater than V_{OUT} + 1 V. When the input voltage is greater than V_{OUT} + 1 V the LM2936 will be in linear operation, and the output voltage will be regulated; however, the device will be sensitive to any small perturbation of the input voltage. Device dynamic performance is improved when the input voltage is at least 2 V greater than the output voltage.

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8 Application and Implementation

NOTE

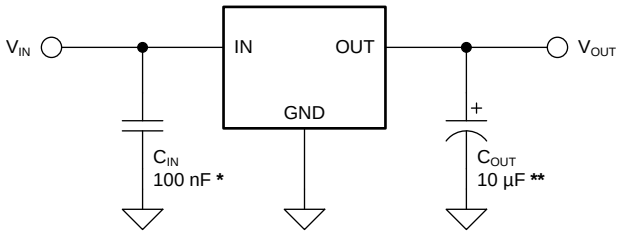
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LM2936 ultra-low quiescent current regulator features low dropout voltage and low current in the standby mode. The LM2936 has a 40-V maximum operating voltage limit, a −40°C to 125°C operating temperature range, –24-V input voltage protection and ±3% output voltage tolerance over the entire output current, input voltage, and temperature range This following section presents a simplified discussion of the design process. Also the WEBENCH® software may be used to generate complete designs. When generating a design, WEBENCH utilizes iterative design procedure and accesses comprehensive databases of components. Please go to www.ti.com for more details.

8.2 Typical Application

Figure 21 shows the typical application circuit for the LM2936. For the LM2936 5-V option, the output capacitor, C_{OUT}, must have a capacitance value of at least 10 µF with an equivalent series resistance (ESR) of at least 300 mΩ, but no more than 8 Ω. For the LM2936 3.3-V and 3-V options, the output capacitor, C_{OUT}, must have a capacitance value of at least 22 µF with an ESR of at least 300 mΩ, but no more than 8 Ω. The minimum capacitance value and the ESR requirements apply across the entire expected operating ambient temperature range.



* C_{IN} is required only if the regulator is located more than 3 inches from the power-supply-filter capacitors.

** Required for stability. C_{OUT} must be at least 10 µF for the LM2936 5-V option, and at least 22 µF for the 3.3-V and 3-V options. Capacitance must be maintained over entire expected operating temperature range, and located as close as possible to the regulator. The ESR, of the C_{OUT} capacitor must at least 300 mΩ, but no more than 8 Ω.

Figure 21. LM2936 Typical Application

8.2.1 Design Requirements

Table 1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Output voltage	5 V
Input voltage	10 V to 26 V
Output current requirement	1 mA to 50 mA
Input capacitor	0.1 µF
Output capacitance	10 µF minimum
Output capacitor ESR value	300 mΩ to 8 Ω

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8.2.2 Detailed Design Procedure

8.2.2.1 External Capacitors

The output capacitor is critical to maintaining regulator stability, and must meet the required conditions for both ESR and minimum amount of capacitance.

8.2.2.1.1 Minimum Capacitance

The minimum output capacitance required to maintain stability is at least 10 µF for the LM2936 5-V option, and at least 22 µF for the 3.3-V and 3-V options. This value may be increased without limit. Larger values of output capacitance will give improved transient response.

8.2.2.1.2 ESR Limits

The ESR of the output capacitor will cause loop instability if it is too high, or too low. ESR, of the C_{OUT} capacitor must at least 300 mΩ, but no more than 8 Ω.

8.2.2.2 Output Capacitor ESR

It is essential that the output capacitor meet the capacitance and ESR requirements, or oscillations can result. The ESR is used with the output capacitance in

Ceramic capacitors (MLCC) can be used for C_{OUT} only if a series resistor is added to simulate the ESR requirement. The ESR is not optional, it is mandatory. Typically, a 500-mΩ to 1-Ω series resistor is used for this purpose. When using ceramic capacitors, due diligence must be given to initial tolerances, capacitance derating due to applied DC voltage, and capacitance variations due to temperature. Dielectric types X5R and X7R are preferred.

8.2.3 Application Curve

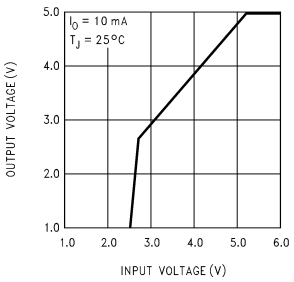


Figure 22. LM2936 V_{OUT} vs. V_{IN}

9 Power Supply Recommendations

This device is designed to operate from an input supply voltage from at least V_{OUT} + 1 V up to a maximum of 40 V. The input supply should be well regulated and free of spurious noise. To ensure that the LM2936 output voltage is well regulated the input supply should be at least V_{OUT} + 2 V. A capacitor at the IN pin may not be specifically required if the bulk input supply filter capacitors are within three inches of the IN pin, but adding one will not be detrimental to operation.

While the LM2936 maintains regulation to V_{IN} = 60 V, it will not withstand a short circuit on the output with V_{IN} above 40 V because of safe operating area limitations in the internal PNP pass device. With V_{IN} above 60 V the LM2936 will break down with catastrophic effects on the regulator and possibly the load as well. Do not use this device in a design where the input operating voltage, including transients, is likely to exceed 60 V.

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10 Layout

10.1 Layout Guidelines

The dynamic performance of the LM2936 is dependent on the layout of the PCB. PCB layout practices that are adequate for typical LDOs may degrade the PSRR, noise, or transient performance of the LM2936. Best performance is achieved by placing C_{IN} and C_{OUT} on the same side of the PCB as the LM2936, and as close as is practical to the package. The ground connections for C_{IN} and C_{OUT} should be back to the LM2936 ground pin using as wide, and as short, of a copper trace as is practical.

Connections using long trace lengths, narrow trace widths, and/or connections through vias should be avoided as these will add parasitic inductances and resistances that will give inferior performance, especially during transient conditions

10.2 Layout Examples

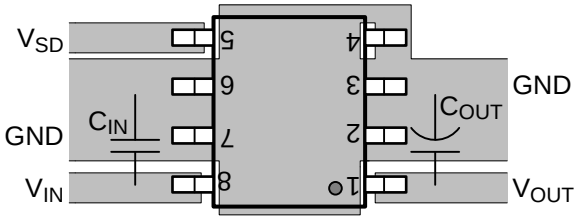


Figure 23. LM2936BM SOIC (D) Layout

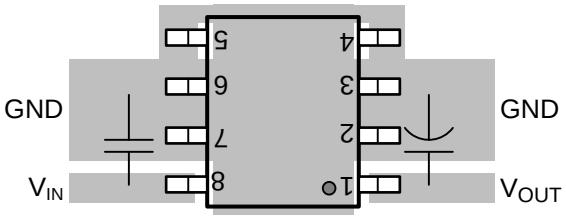


Figure 24. LM2936M SOIC (D) Layout

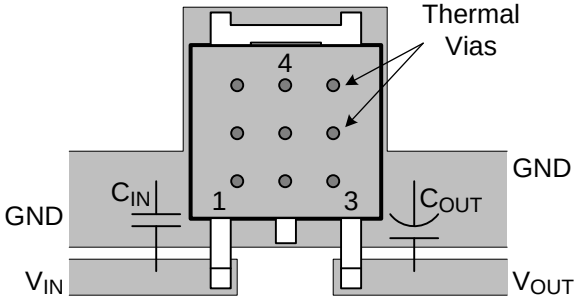


Figure 25. LM2936 TO-252 (NDP) Layout

10.3 Thermal Considerations

Due to the power dissipation characteristics of the available packages ($R_{\theta JA}$), full output current cannot be ensured for all combinations of ambient temperature and input voltage.

Exceeding the maximum allowable power dissipation as defined by the final package $R_{\theta JA}$ will cause excessive die junction temperature, and the regulator may go into thermal shutdown.

Power dissipation, P_D, is calculated from the following formula:

$$P_D = ((V_{IN} - V_{OUT}) \times I_{OUT}) + (V_{IN} \times I_{GND}) \quad (1)$$

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Thermal Considerations (continued)

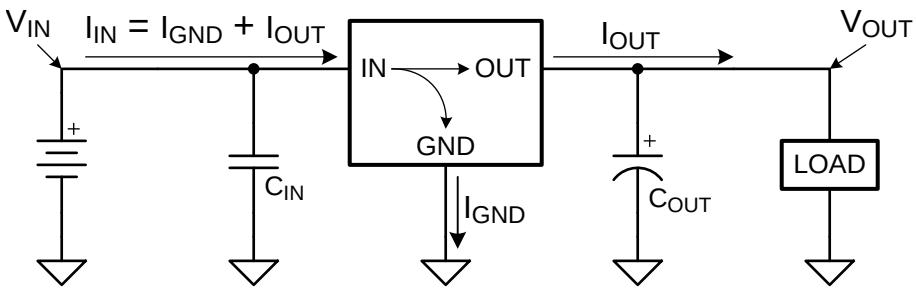


Figure 26. Current Paths for Power Dissipation Calculation

Knowing the power dissipation (P_D), the thermal resistance of the package ($R_{\theta JA}$), and the ambient temperature (T_A), the junction temperature (T_J) can be estimated using the following formula:

$$T_J = (P_D \times R_{\theta JA}) + T_A \quad (2)$$

Knowing the thermal resistance of the package ($R_{\theta JA}$), the ambient temperature (T_A), and the maximum allowed operating junction temperature (T_J) of 125°C, the maximum power dissipation can be estimated using the following formula:

$$P_{D(MAX)} = (125°C - T_A) / R_{\theta JA} \quad (3)$$

Alternately, solving for the required thermal resistance ($R_{\theta JA}$):

$$R_{\theta JA} = (125°C - T_A) / P_{D(MAX)} \quad (4)$$

The maximum allowed P_D information from Equation 3 can be used to estimate the maximum allowed load current (I_{OUT}), or the maximum allowed $_{VIN}$:

$$V_{IN(MAX)} = (P_{D(MAX)} / I_{OUT}) + V_{OUT} \quad (5)$$

$$I_{OUT(MAX)} = (P_{D(MAX)} / (V_{IN} - V_{OUT})) \quad (6)$$

As an example, an application requires : V_{IN} = 14 V, V_{OUT} = 5 V, I_{OUT} = 25 mA, and T_A = 85°C. Find the maximum $R_{\theta JA}$ to keep the junction temperature under 125°C.

$$R_{\theta JA} \le (125°C - T_A) / P_{D(MAX)} \quad (7)$$

$$R_{\theta JA} \le (125°C - 85°C) / ((14\ V - 5\ V) \times 0.025\ A) \quad (8)$$

$$R_{\theta JA} \le 40°C / 0.225W \quad (9)$$

$$R_{\theta JA} \le 177°C/W \quad (10)$$

The EIA/JEDEC standard (JESD51-2) provides methodologies to estimate the junction temperature from external measurements (Ψ_{JB} references the temperature at the PCB, and Ψ_{JT} references the temperature at the top surface of the package) when operating under steady-state power dissipation conditions. These methodologies have been determined to be relatively independent of the copper thermal spreading area that may be attached to the package DAP when compared to the more typical $R_{\theta JA}$. Refer to Texas Instruments Application Report *Semiconductor and IC Package Thermal Metrics* (SPRA953), for specifics.

On the 8-pin SOIC (D) package, the four ground pins are thermally connected to the backside of the die. Adding approximately 0.04 square inches of 2 oz. copper pad area to these four pins will improve the JEDEC $R_{\theta JA}$ rating from 111.4°C/W to approximately 100°C/W. If this extra copper area is placed directly beneath the SOIC package there should not be any impact on board density.

The LM2936 has an internally set thermal shutdown point of typically 160°C. Thermal shutdown is outside the ensured operating temperature range and is intended as a safety feature only. Continuous operation near the thermal shutdown temperature should be avoided as it may have a negative affect on the life of the device.

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11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation see the following:

Texas Instruments Application Report *Semiconductor and IC Package Thermal Metrics* (SPRA953)

11.2 Trademarks

WEBENCH is a registered trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.4 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2936BM-3.3/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3
LM2936BM-3.3/NOPB.B	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3
LM2936BM-5.0/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0
LM2936BM-5.0/NOPB.B	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0
LM2936BMX-3.3/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3
LM2936BMX-3.3/NOPB.B	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3
LM2936BMX-5.0/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0
LM2936BMX-5.0/NOPB.B	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0
LM2936DT-3.0/NOPB	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.0
LM2936DT-3.0/NOPB.B	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.0
LM2936DT-3.3/NOPB	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3
LM2936DT-3.3/NOPB.B	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3
LM2936DT-5.0/NOPB	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0
LM2936DT-5.0/NOPB.B	Active	Production	TO-252 (NDP) | 3	75 | TUBE	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0
LM2936DTX-3.3/NOPB	Active	Production	TO-252 (NDP) | 3	2500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3
LM2936DTX-3.3/NOPB.B	Active	Production	TO-252 (NDP) | 3	2500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2936DTX-5.0/NOPB	Active	Production	TO-252 (NDP) | 3	2500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0
LM2936DTX-5.0/NOPB.B	Active	Production	TO-252 (NDP) | 3	2500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0
LM2936HVBMA-3.3/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	2936H BM3.3
LM2936HVBMA-5.0/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	2936H BM5.0
LM2936HVBMAX3.3/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-	2936H BM3.3
LM2936HVBMAX5.0/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-	2936H BM5.0
LM2936HVMA-5.0/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	2936H M-5.0
LM2936HVMAX-5.0/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	2936H M-5.0
LM2936M-3.0/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-3
LM2936M-3.0/NOPB.B	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-3
LM2936M-3.3/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6-3.3
LM2936M-3.3/NOPB.B	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6-3.3
LM2936M-5.0/NOPB	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-5
LM2936M-5.0/NOPB.B	Active	Production	SOIC (D) | 8	95 | TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-5
LM2936MM-3.0/NOPB	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBC
LM2936MM-3.0/NOPB.B	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBC
LM2936MM-3.3/NOPB	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBB
LM2936MM-3.3/NOPB.B	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBB
LM2936MM-5.0/NOPB	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBA
LM2936MM-5.0/NOPB.B	Active	Production	VSSOP (DGK) | 8	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBA

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2936MMX-3.3/NOPB	Active	Production	VSSOP (DGK) | 8	3500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBB
LM2936MMX-3.3/NOPB.B	Active	Production	VSSOP (DGK) | 8	3500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBB
LM2936MMX-5.0/NOPB	Active	Production	VSSOP (DGK) | 8	3500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBA
LM2936MMX-5.0/NOPB.B	Active	Production	VSSOP (DGK) | 8	3500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KBA
LM2936MP-3.0/NOPB	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-	KACA
LM2936MP-3.0/NOPB.B	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KACA
LM2936MP-3.3/NOPB	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KABA
LM2936MP-3.3/NOPB.B	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KABA
LM2936MP-5.0/NOPB	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KAAA
LM2936MP-5.0/NOPB.B	Active	Production	SOT-223 (DCY) | 4	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KAAA
LM2936MPX-3.0/NOPB	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KACA
LM2936MPX-3.0/NOPB.B	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KACA
LM2936MPX-3.3/NOPB	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KABA
LM2936MPX-3.3/NOPB.B	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KABA
LM2936MPX-5.0/NOPB	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KAAA
LM2936MPX-5.0/NOPB.B	Active	Production	SOT-223 (DCY) | 4	2000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	KAAA
LM2936MX-3.3/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6-3.3
LM2936MX-3.3/NOPB.B	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6-3.3
LM2936MX-5.0/NOPB	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-5
LM2936MX-5.0/NOPB.B	Active	Production	SOIC (D) | 8	2500 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-5
LM2936Z-3.3/NOPB	Active	Production	TO-92 (LP) | 3	1800 | BULK	Yes	SN	N/A for Pkg Type	-40 to 125	LM2936 Z-3.3
LM2936Z-3.3/NOPB.B	Active	Production	TO-92 (LP) | 3	1800 | BULK	Yes	SN	N/A for Pkg Type	-40 to 125	LM2936 Z-3.3
LM2936Z-5.0/LFT1	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM293 6Z-5
LM2936Z-5.0/LFT1.B	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 125	LM293 6Z-5

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2936Z-5.0/LFT3	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM293 6Z-5
LM2936Z-5.0/LFT3.B	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 125	LM293 6Z-5
LM2936Z-5.0/LFT4	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM293 6Z-5
LM2936Z-5.0/LFT4.B	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 125	LM293 6Z-5
LM2936Z-5.0/NOPB	Active	Production	TO-92 (LP) | 3	1800 | SMALL T&R	Yes	SN	N/A for Pkg Type	-40 to 125	LM293 6Z-5
LM2936Z-5.0/NOPB.B	Active	Production	TO-92 (LP) | 3	1800 | SMALL T&R	Yes	SN	N/A for Pkg Type	-40 to 125	LM293 6Z-5

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

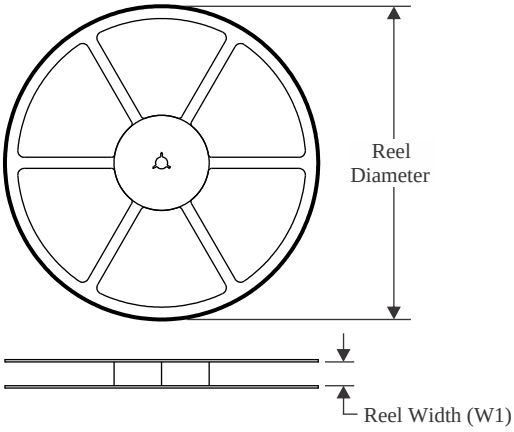
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and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

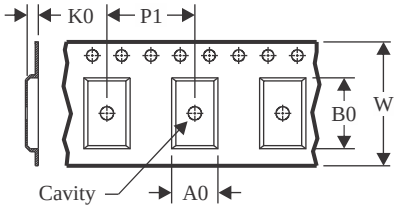
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

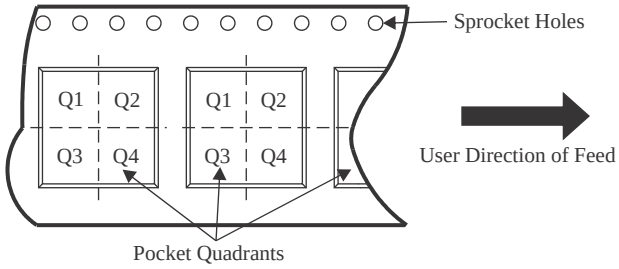


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

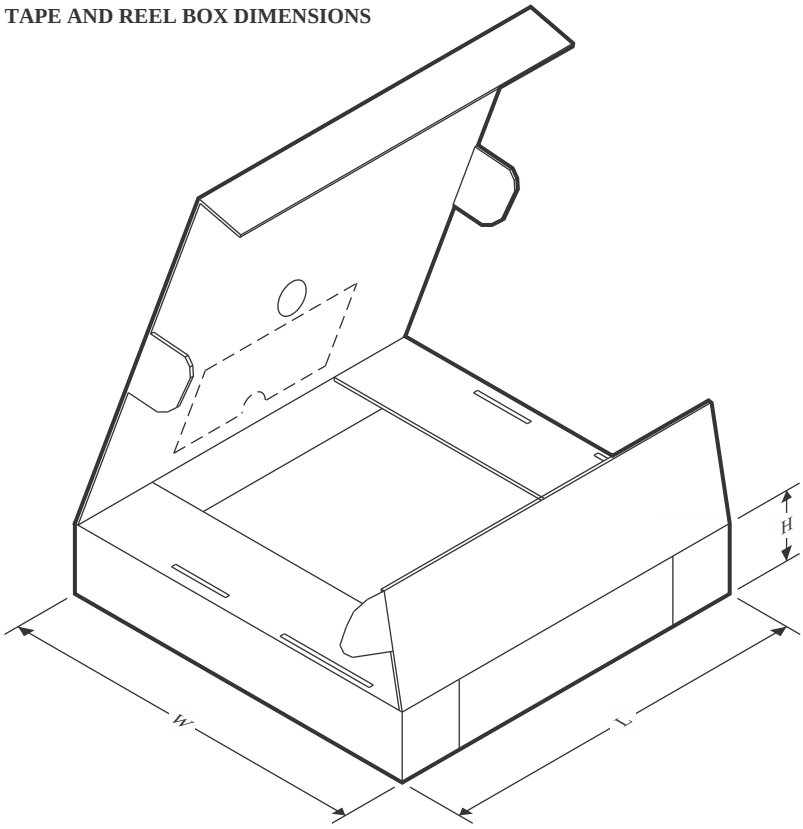


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2936BMX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936BMX-5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936DTX-3.3/NOPB	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936DTX-5.0/NOPB	TO-252	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936HVBMAX3.3/ NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936HVBMAX5.0/ NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936HVMAX-5.0/ NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936MM-3.0/NOPB	VSSOP	DGK	8	1000	177.8	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-3.3/NOPB	VSSOP	DGK	8	1000	177.8	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-5.0/NOPB	VSSOP	DGK	8	1000	177.8	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-3.3/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-5.0/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MP-3.0/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-3.3/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2936MP-5.0/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.0/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.3/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-5.0/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2936MX-5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS

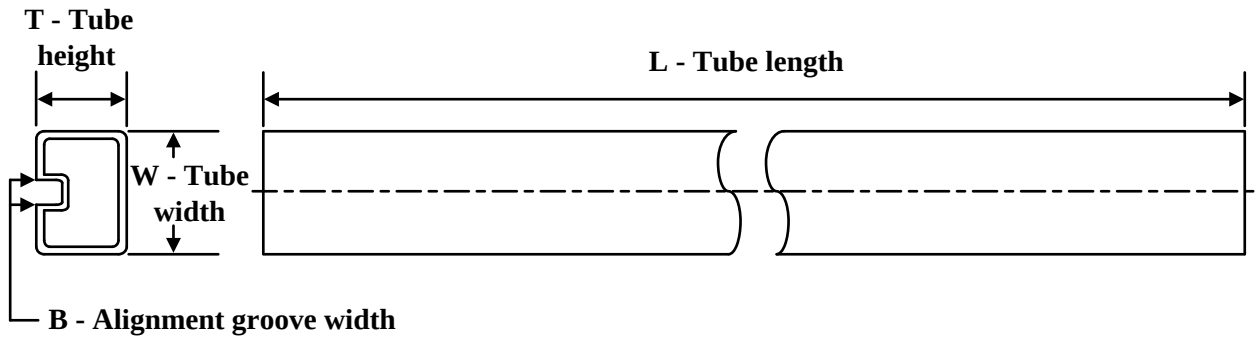


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2936BMX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936BMX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936DTX-3.3/NOPB	TO-252	NDP	3	2500	356.0	356.0	36.0
LM2936DTX-5.0/NOPB	TO-252	NDP	3	2500	356.0	356.0	36.0
LM2936HVBMAX3.3/ NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVBMAX5.0/ NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVMAX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MM-3.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-3.3/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-5.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MMX-3.3/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MMX-5.0/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MP-3.0/NOPB	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM2936MP-3.3/NOPB	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM2936MP-5.0/NOPB	SOT-223	DCY	4	1000	367.0	367.0	35.0
LM2936MPX-3.0/NOPB	SOT-223	DCY	4	2000	367.0	367.0	35.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2936MPX-3.3/NOPB	SOT-223	DCY	4	2000	367.0	367.0	35.0
LM2936MPX-5.0/NOPB	SOT-223	DCY	4	2000	367.0	367.0	35.0
LM2936MX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

TUBE



*All dimensions are nominal

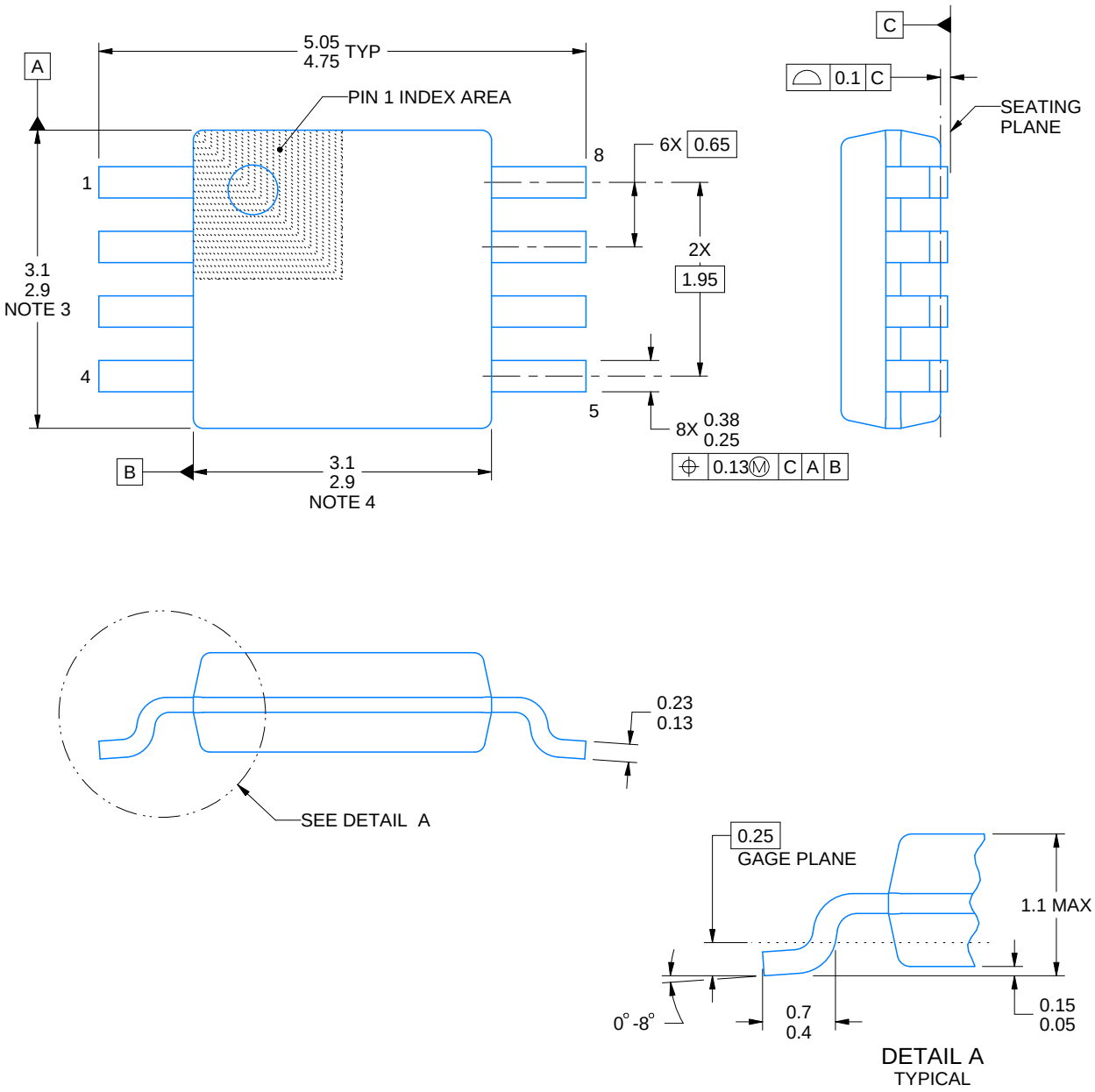
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LM2936BM-3.3/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936BM-3.3/NOPB.B	D	SOIC	8	95	495	8	4064	3.05
LM2936BM-5.0/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936BM-5.0/NOPB.B	D	SOIC	8	95	495	8	4064	3.05
LM2936DT-3.0/NOPB	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936DT-3.0/NOPB.B	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936DT-3.3/NOPB	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936DT-3.3/NOPB.B	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936DT-5.0/NOPB	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936DT-5.0/NOPB.B	NDP	TO-252	3	75	508	20	4165.6	3.1
LM2936HVBMA-3.3/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936HVBMA-5.0/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936HVMA-5.0/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936M-3.0/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936M-3.0/NOPB.B	D	SOIC	8	95	495	8	4064	3.05
LM2936M-3.3/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936M-3.3/NOPB.B	D	SOIC	8	95	495	8	4064	3.05
LM2936M-5.0/NOPB	D	SOIC	8	95	495	8	4064	3.05
LM2936M-5.0/NOPB.B	D	SOIC	8	95	495	8	4064	3.05

PACKAGE OUTLINE

DGK0008A

VSSOP - 1.1 mm max height

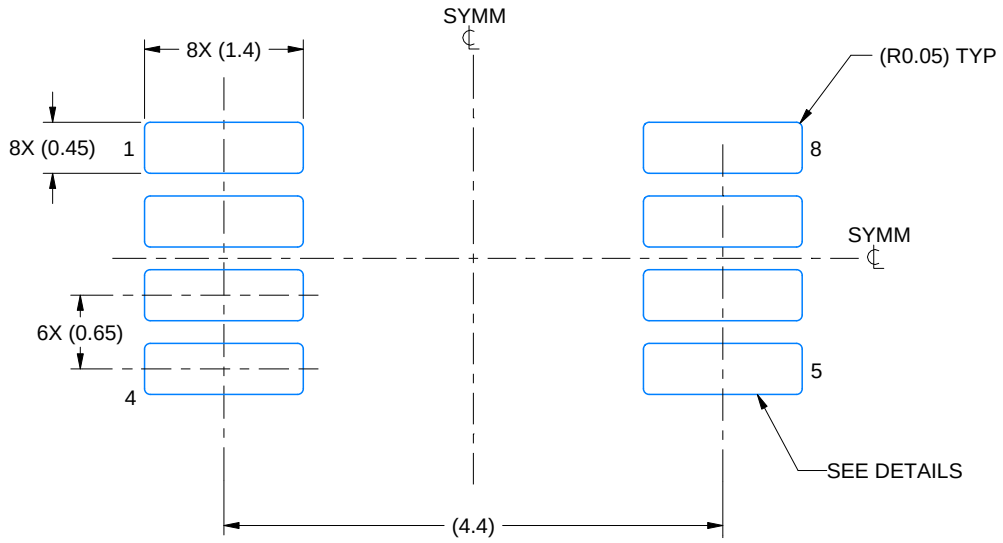
SMALL OUTLINE PACKAGE



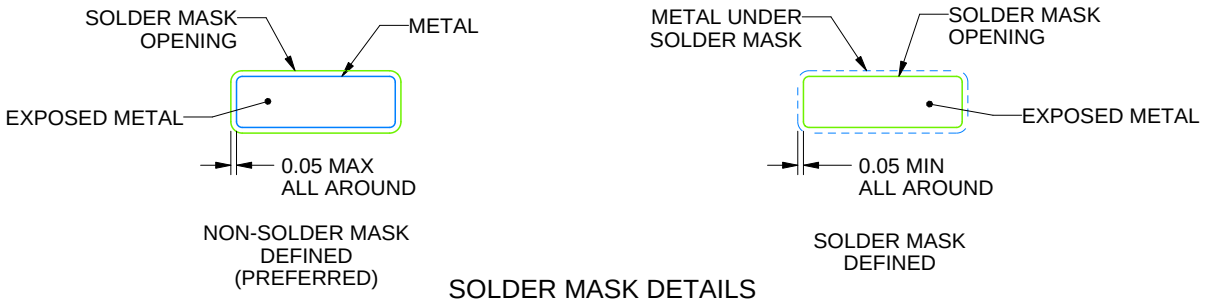
PowerPAD is a trademark of Texas Instruments.

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 15X

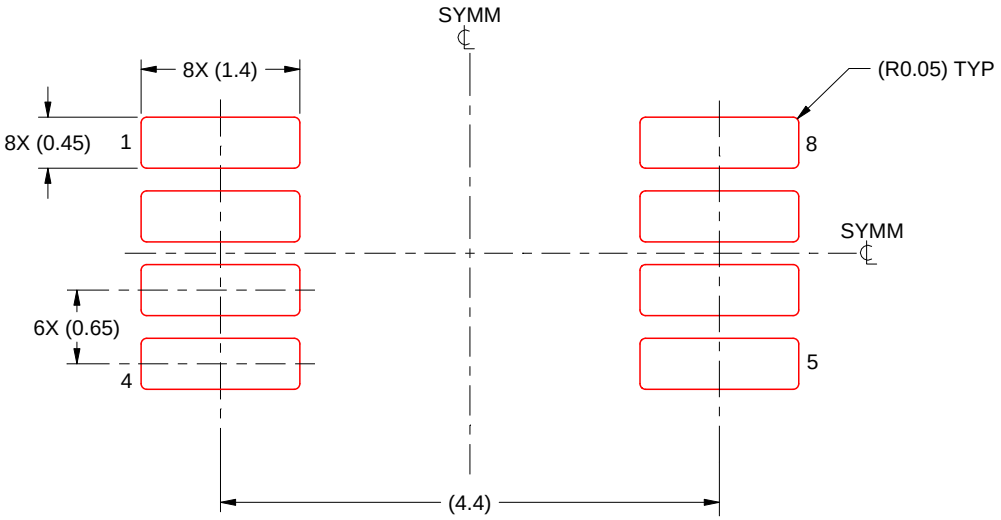


SOLDER MASK DETAILS

4214862/A 04/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.



SOLDER PASTE EXAMPLE
SCALE: 15X

4214862/A 04/2023

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

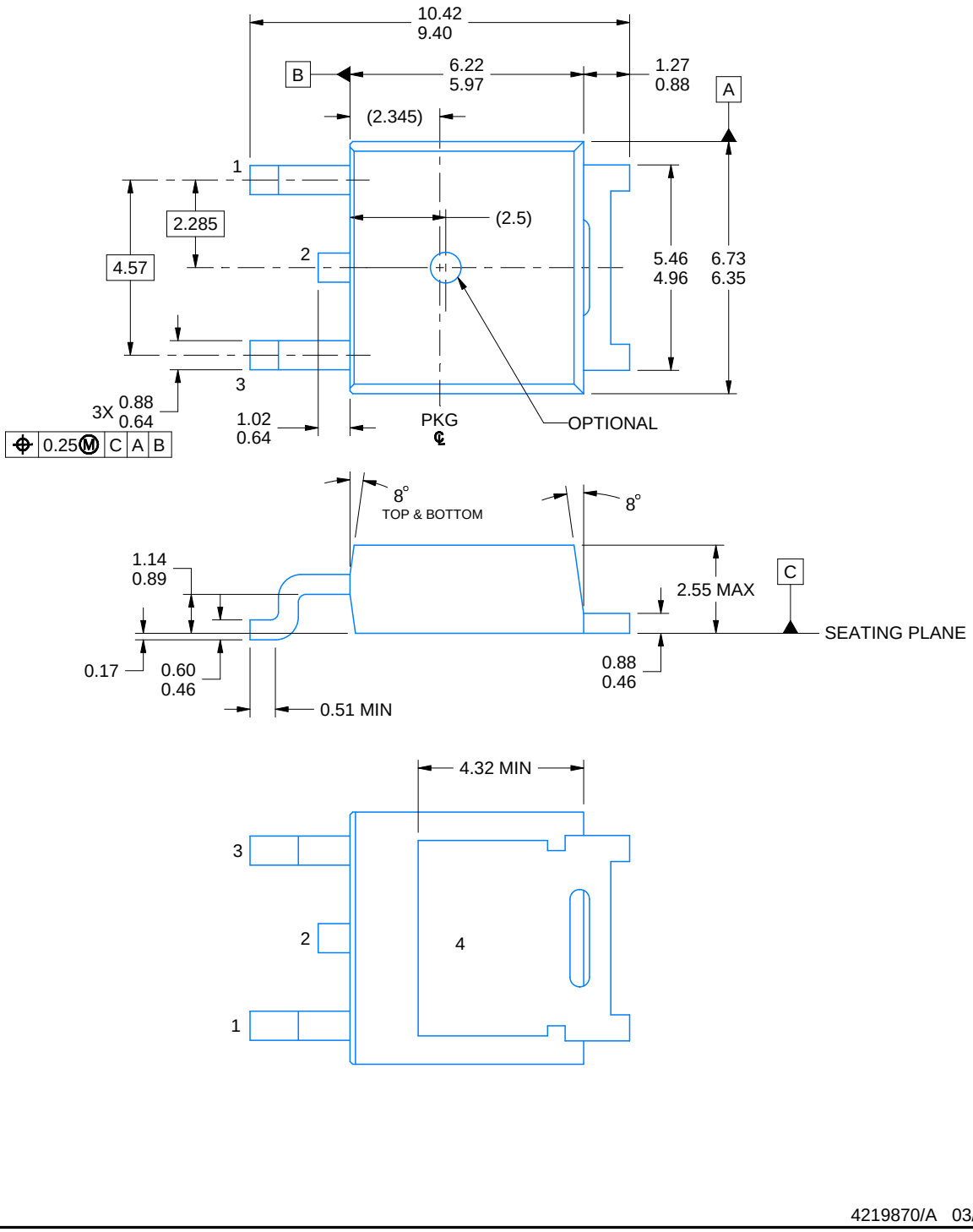
NDP0003B



PACKAGE OUTLINE

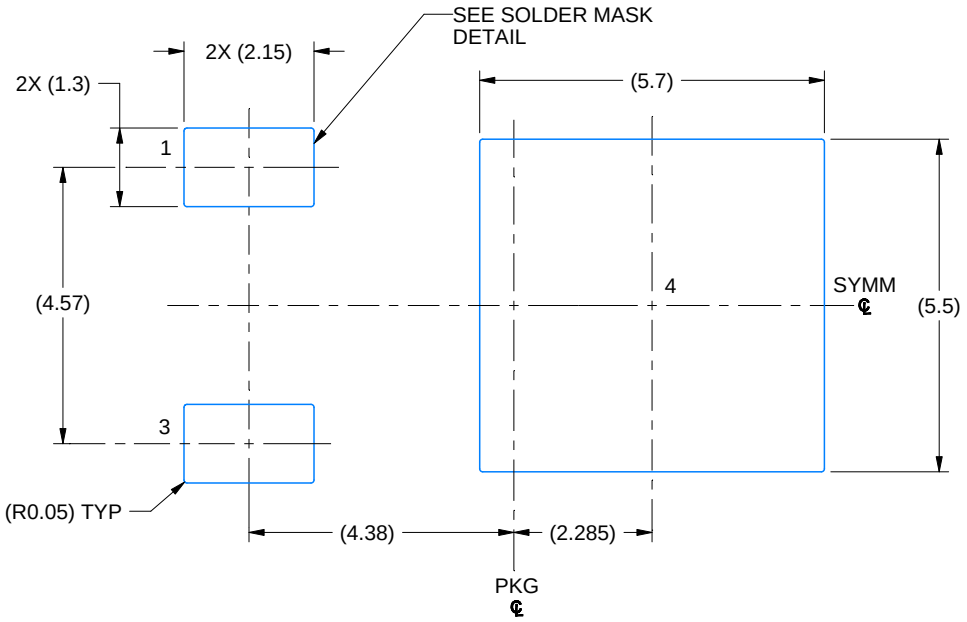
TO-252 - 2.55 mm max height

TRANSISTOR OUTLINE

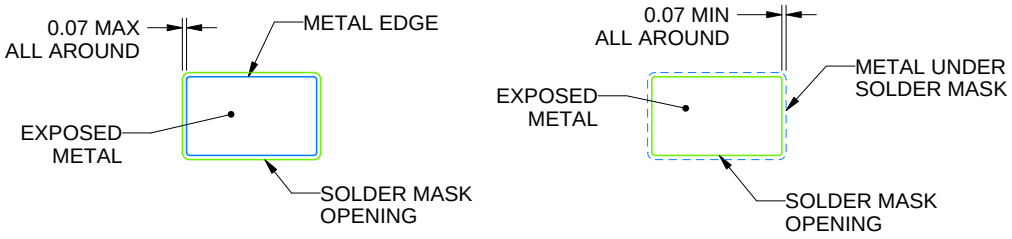


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-252.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 8X

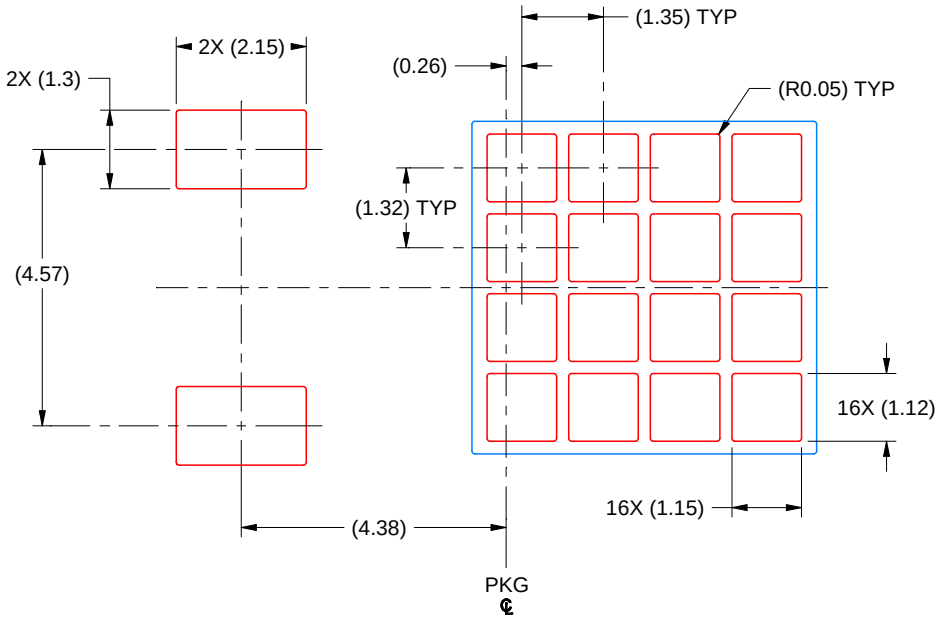


SOLDER MASK DETAIL

4219870/A 03/2018

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
5. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.

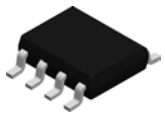


SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 8X

4219870/A 03/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

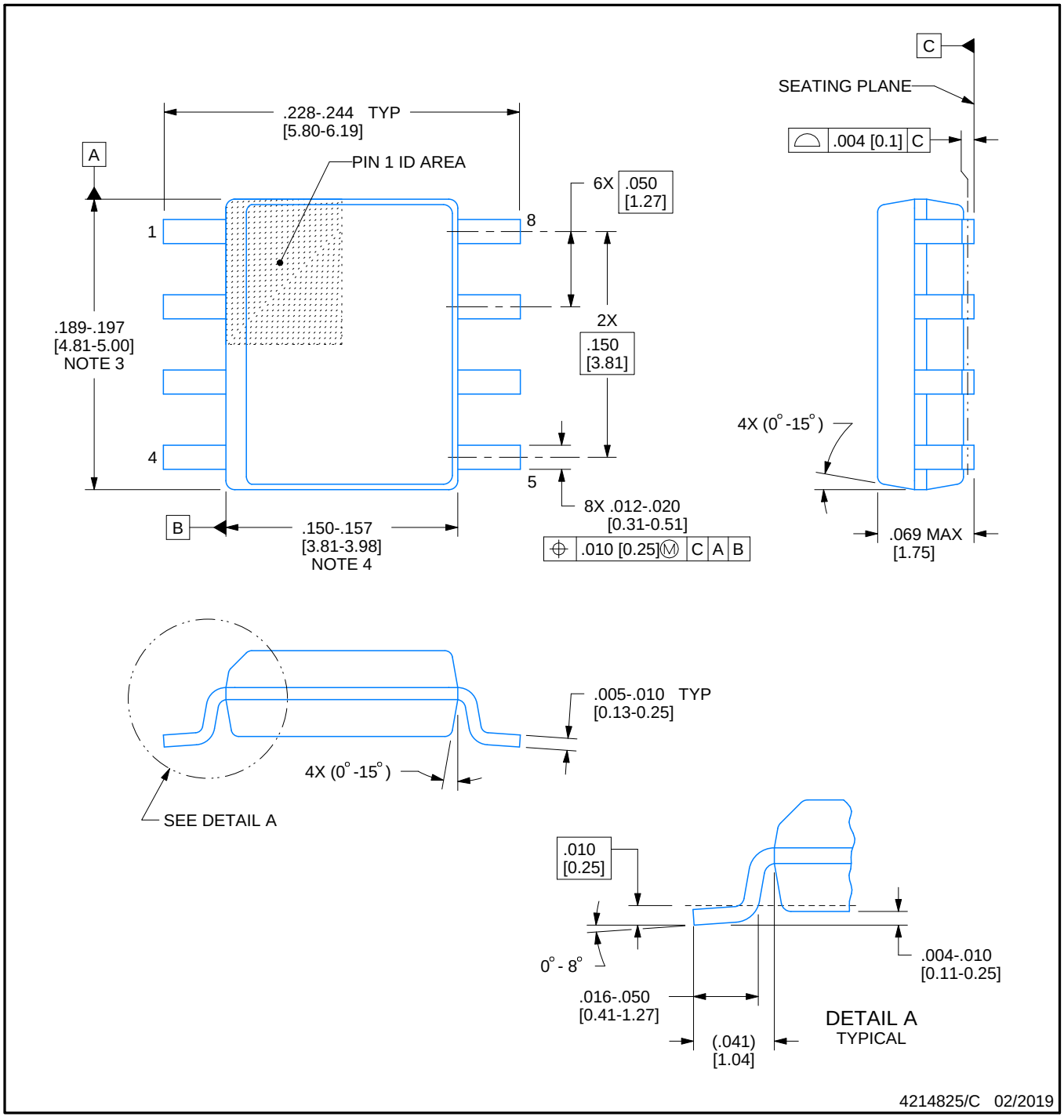


PACKAGE OUTLINE

D0008A

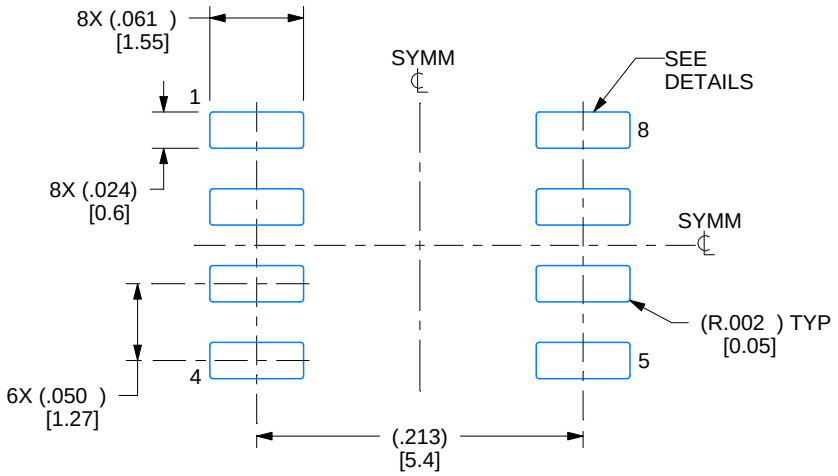
SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT

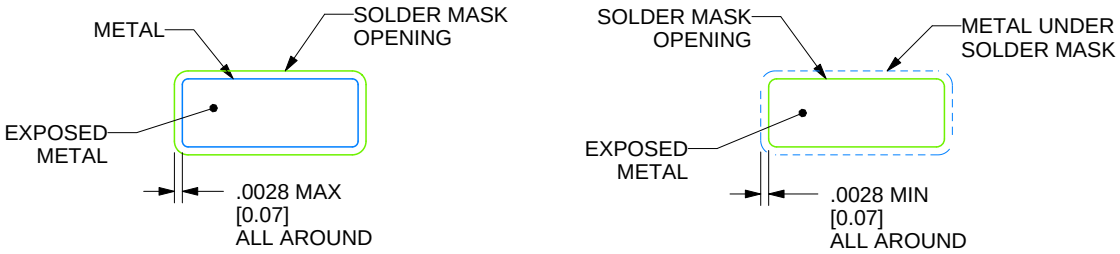


NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

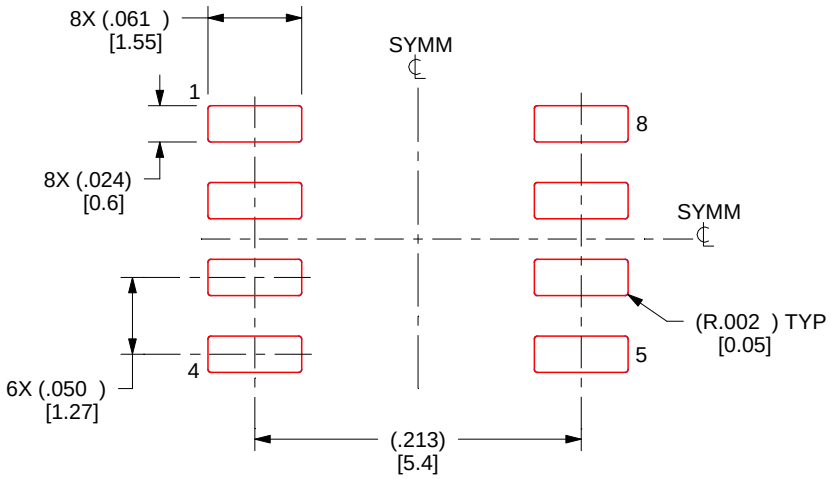
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

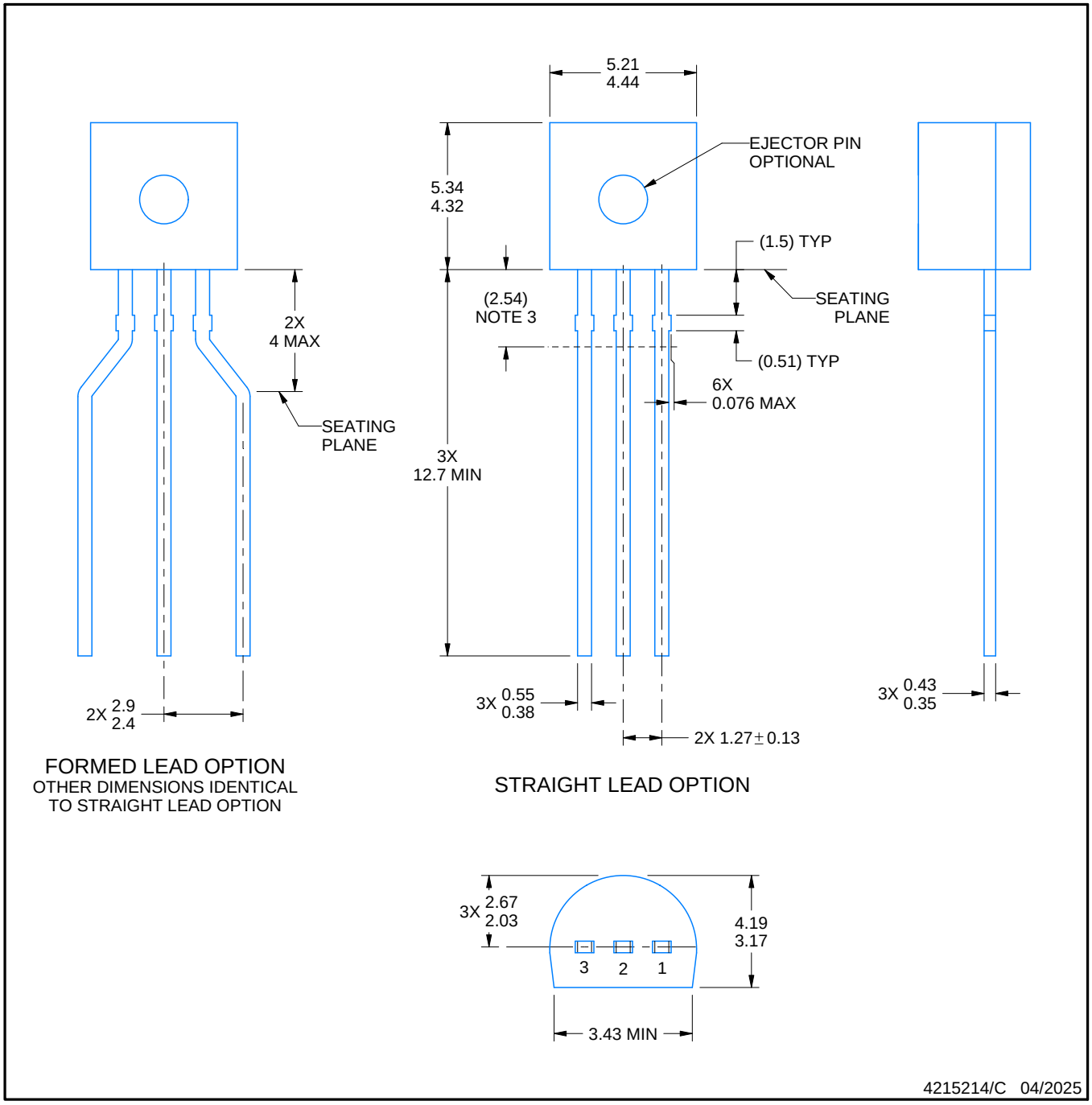
LP0003A



PACKAGE OUTLINE

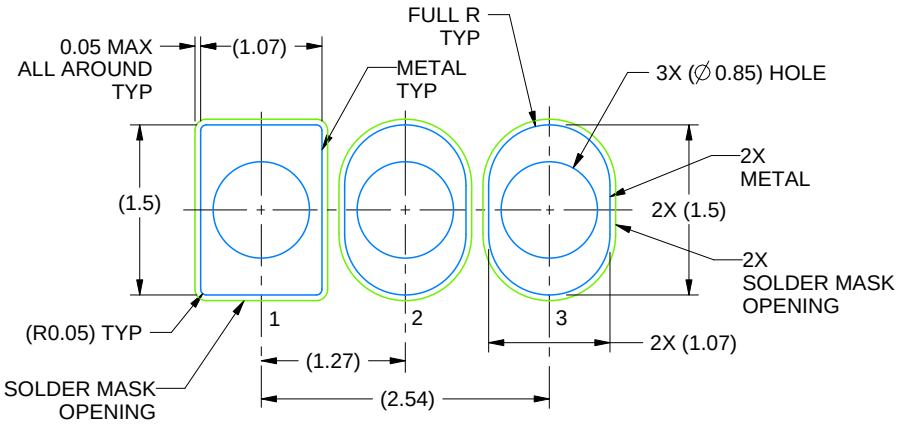
TO-92 - 5.34 mm max height

TO-92

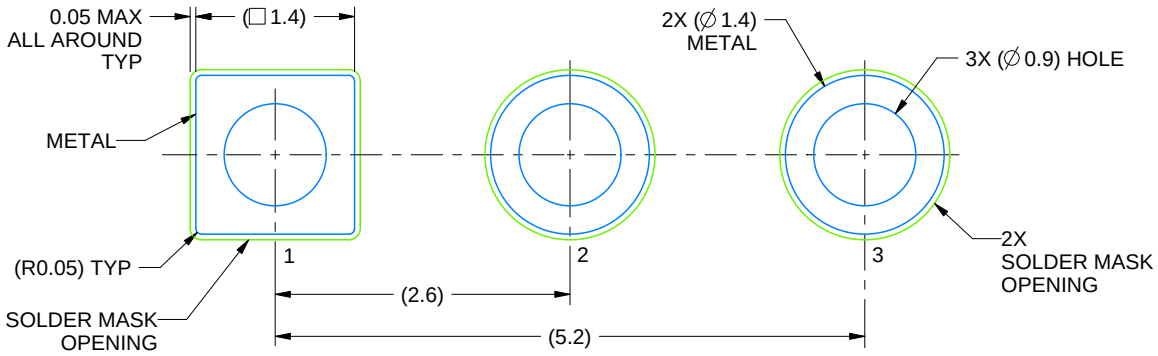


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Lead dimensions are not controlled within this area.
4. Reference JEDEC TO-226, variation AA.
5. Shipping method:
   a. Straight lead option available in bulk pack only.
   b. Formed lead option available in tape and reel or ammo pack.
   c. Specific products can be offered in limited combinations of shipping medium and lead options.
   d. Consult product folder for more information on available options.



LAND PATTERN EXAMPLE
STRAIGHT LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X



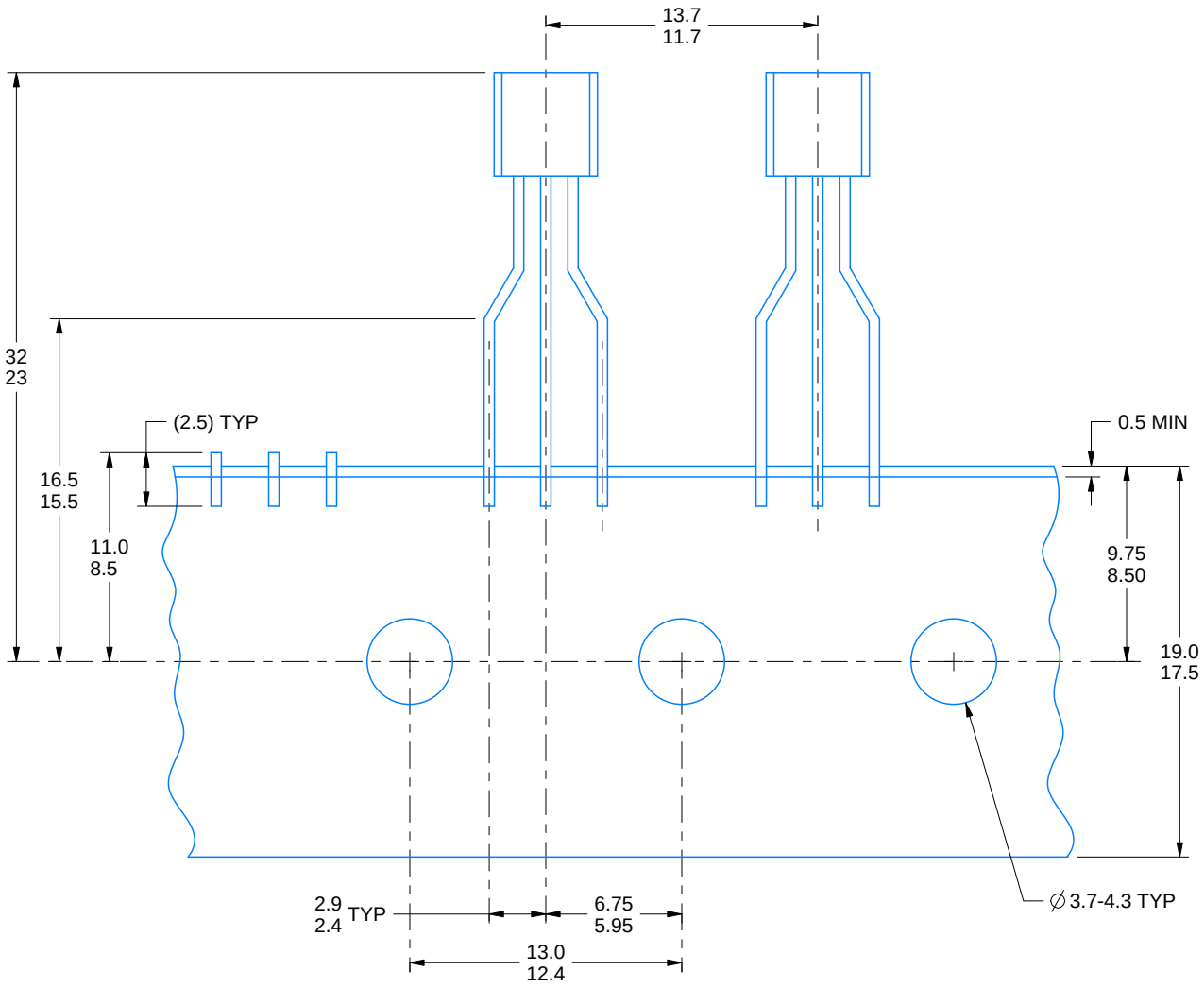
LAND PATTERN EXAMPLE
FORMED LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X

4215214/C 04/2025

LP0003A

TO-92 - 5.34 mm max height

TO-92



FOR FORMED LEAD OPTION PACKAGE

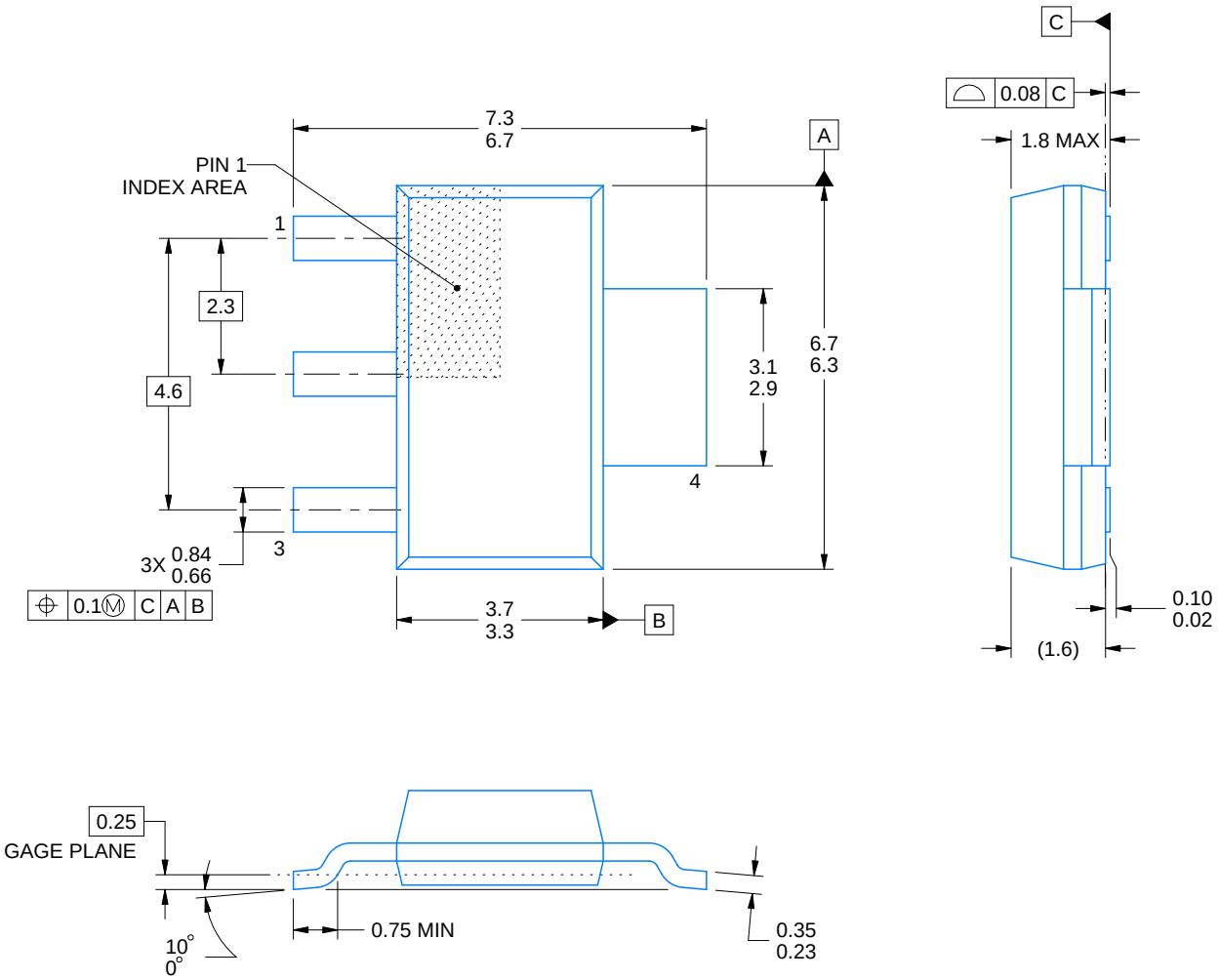
4215214/C 04/2025

PACKAGE OUTLINE

DCY0004A

SOT-223 - 1.8 mm max height

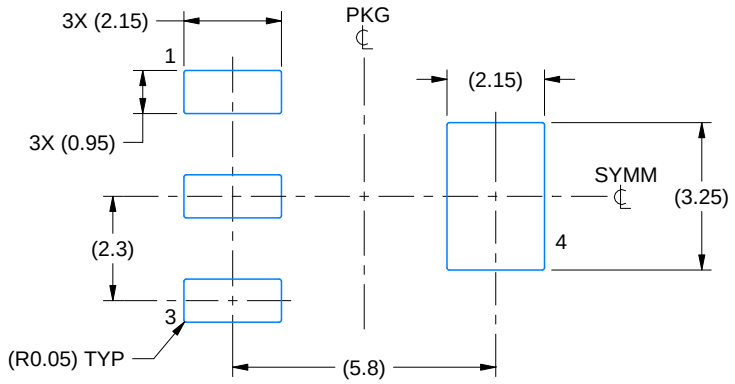
PLASTIC SMALL OUTLINE



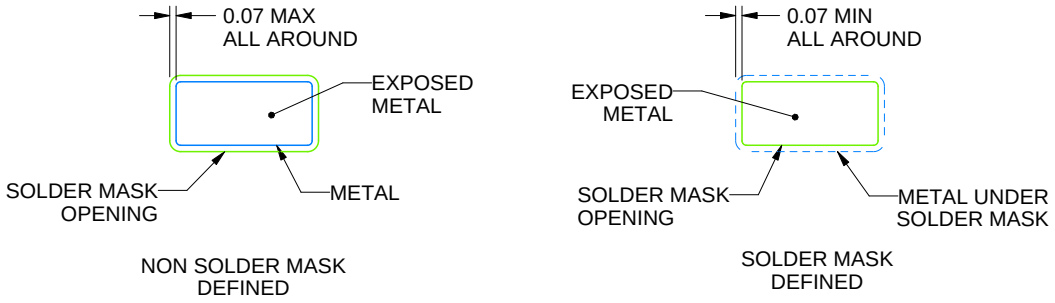
4214843/C 05/2026

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC TO-261.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4214843/C 05/2026

NOTES: (continued)

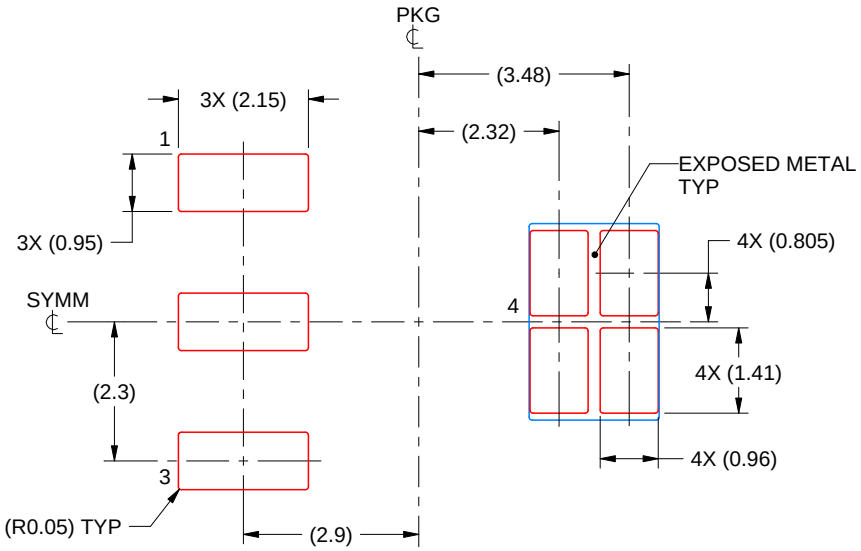
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DCY0004A

SOT-223 - 1.8 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4214843/C 05/2026

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Last updated 10/2025

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